EVENSON MCKEOWN, EDWARDS & LENAHAN, 🖳 L.C. 0 G Street, N.W., Suite 70 Washington, D.C. 20005

(202) 628-8800

December 14, 2000

Box PATENT APPLICATION Commissioner for Patents Washington, D.C. 20231

Re: New U.S. Patent Appln. Our Ref: 381NT/49487

Sir:

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Transmitted herewith for filing is the patent application of:

Kenji HORII; Yasutsugu YOSHIMURA; Tadashi NISHINO; Takashi KAMOSHITA; Takayoshi TOMINO; Fuminori ISHIKAWA; Takao FUNAMOTO; Takashi MASHIKO; Kenjiro NARITA; Jong-Keun KIM; Ki-Chol KIM; Jong-Sub LEE; Hwang-Kyu HWANG; Jung-Sik LEE and Jin-Hee KIM

entitled: METHOD OF BONDING METAL PLATES, APPARATUS THEREFOR AND HOT STRIP MILL

Enclosed are:

- Specification, including 23 claims (51 pages).
- 24 Sheets of X Formal drawings showing Figs. 1-7, 8a-b, 9a-b, 10a-b, 11a-b, 12-15, 16a-d, 17-20, 21a-b, 22a-b, 23a-c, 24 and
- \underline{X} Declaration and Power of Attorney (executed). 3.
- Assignment of the invention to HITACHI, LTD., POHANG IRON & STEEL INDUSTRIAL SCIENCE CO., LTD. AND RESEARCH INSTITUTE OF TECHNOLOGY.
- Priority is being claimed under 35 U.S.C. §119 and 37 C.F.R. §1.55 based on Priority Document Japanese Patent Application No. 11-345215, filed in Japan December 14, 1999, and Japanese Patent Application No. 2000-316522, filed in Japan October 17, 2000.
- Preliminary Amendment 6.
- The filing fee has been calculated as shown below: 7.

Indep Multi	Fee Claims endent Claims ple Dependent Filing Fee	$\frac{46}{6}$ Claim	- 20 - 3 Prese	= -	3_	x	\$355/710 \$ 9/18 \$40/80 \$135/270	=	\$710.00 \$468.00 \$240.00 \$ \$1418.00
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Two checks in the amount of \$1,418.00 for the filing fee and \$40.00for the assignment recording fee are enclosed. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Deposit Account No. 05-1323 (Docket #381NT/49487). A duplicate copy of this sheet is enclosed.

PATENT TRADEMARK OFFICE

Respectfully submitted,

Donald D. Evenson

Reg. No. 26,160

DDE: mkh